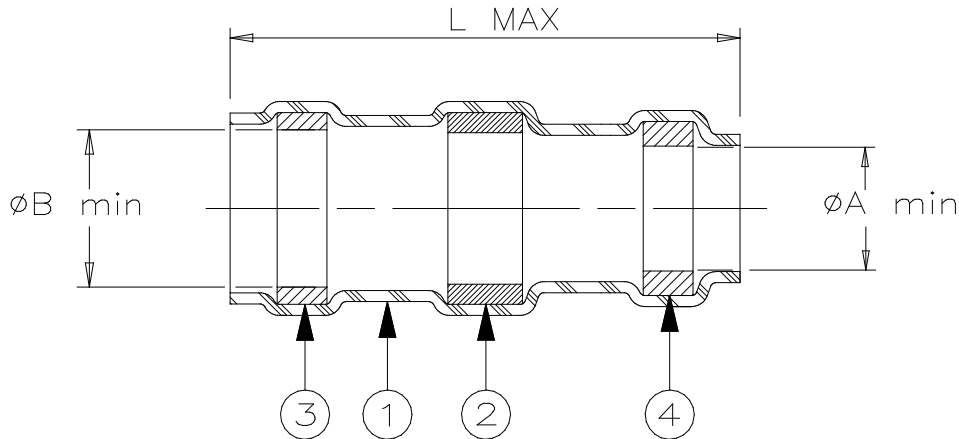


## CUSTOMER DRAWING



Product Name	Product Dimensions		
	L MAX	øA min	øB min
D-108-00	17.25 (0.680)	1.9 (0.075)	2.4 (0.095)
D-108-01	17.25 (0.680)	2.8 (0.110)	3.15 (0.125)
D-108-02	17.25 (0.680)	4.4 (0.175)	5.0 (0.200)
D-108-03	20.5 (0.810)	7.1 (0.280)	7.6 (0.300)


### MATERIAL

1. INSULATION SLEEVE: HEAT-SHRINKABLE, RADIATION CROSS-LINKED POLYVINYLIDENE FLOURIDE, TRANSPARENT BLUE.
2. SOLDER PREFORM WITH FLUX:  
Solder: Sn96 Ag4 per ANSI J-STD-006.  
Flux: ROL0 per ANSI J-STD-004.
- 3 & 4. MELTABLE INSERTS: Polyolefin-based thermoplastic. Color: red.

### NOTES

- A. The parts covered by this SCD are for use in attaching a ground wire to the shield of a cable. They may be used on cables rated for at least 135°C minimum, having silver plated copper shields and meeting the dimensional criteria shown in the table.
- B. Parts will meet requirements of Raychem specification RT-1404 and National Aerospace Standard NAS-1747 when installed per TE Connectivity-approved convection or infrared tools in accordance with Raychem assembly procedure RCPS-100-70.  
TEMPERATURE RATING: -55°C to +175°C.

TE Connectivity, TE connectivity (logo), Raychem, Thermofit, and SolderSleeve are trademarks

		<b>Raychem</b> THERMOFIT DEVICES		TITLE: <b>SOLDERSLEEVE SHIELD TERMINATOR</b>						
UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN MILLIMETERS. INCHES DIMENSIONS ARE BETWEEN BRACKETS.				DOCUMENT NO. : <b>D-108-00/-01/-02/-03</b>						
TOLERANCES: 0.00 N/A 0.0 N/A 0 N/A		ANGLES: N/A  ROUGHNESS IN MICRON		TE Connectivity reserves the right to amend this drawing at any time. Users should evaluate the suitability of the product for their application.		Revision: 4		Issue Date: March 2020		
DRAWN BY: M. FORONDA		DATE: 04/09/98		ECO: ECO-20-003568		SCALE: None		SIZE: A		SHEET: 1 of 1

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